## IRLZ24

Vishay Siliconix



**TO-220AB** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>gs</sub> (nC)

Q<sub>gd</sub> (nC)

Q<sub>q</sub> (Max.) (nC)

Configuration

# **Power MOSFET**

S

N-Channel MOSFET

0.10

60

18

4.5

12

Single

 $V_{GS} = 5.0 V$ 

## FEATURES

- Dynamic dV/dt rating
- · Logic-level gate drive
- R<sub>DS(on)</sub> specified at V<sub>GS</sub> = 4 V and 5 V
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### DESCRIPTION

Third generation power MOSFETs from Vishay provides the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRLZ24PbF			
Lead (Pb)-free and halogen-free	IRLZ24PbF-BE3			

<b>ABSOLUTE MAXIMUM RATINGS (T</b> C	= 25 °C, un	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	60	- V	
Gate-source voltage			V <sub>GS</sub>	± 10		
Continuous drain current	V <sub>GS</sub> at 5 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	- I <sub>D</sub>	17		
	V <sub>GS</sub> at 5 V	T <sub>C</sub> = 100 °C		12	A	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	68	1	
Linear derating factor			0.40	W/°C		
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	64.1	mJ		
Maximum power dissipation	T <sub>C</sub> = 25 °C		PD	60	W	
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C		
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s			300 <sup>d</sup>	7	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
			-	1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

- b.  $V_{DD}$  = 25 V, starting T<sub>J</sub> = 25 °C, L = 444 µH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 17 A (see fig. 12)
- c.  $I_{SD} \leq 17$  A, dI/dt  $\leq 140$  A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 175$  °C

d. 1.6 mm from case

S21-1046-Rev. E, 25-Oct-2021

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PARAMETER	SYMBOL	TYP.	МАХ			UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	-				
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50			°C/W			
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	2.5		-			
	"thJC		2.5					
<b>SPECIFICATIONS</b> ( $T_J = 25 \degree C$ ,	unless other	vise noted)						
PARAMETER	SYMBOL		CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	OTMEDEL		Conditions	Wint.		MAA.		
Drain-source breakdown voltage	V <sub>DS</sub>	Voo = 0	V, I <sub>D</sub> = 250 μA	60	-	-	v	
V <sub>DS</sub> temperature coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>		o 25 °C, I <sub>D</sub> = 1 mA		0.060	<u> </u>	V/°C	
Gate-source threshold voltage				1.0	-	2.0	V/C	
Gate-source leakage	V <sub>GS(th)</sub>		$V_{DS} = V_{GS}, I_D = 250 \ \mu A$ $V_{GS} = \pm 10$			± 100	nA	
Gale-Source leakage	I <sub>GSS</sub>			-		± 100		
Zero gate voltage drain current	I <sub>DSS</sub>		0 V, V <sub>GS</sub> = 0 V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μA	
		$V_{DS} = 48 \text{ V}, \text{ V}_{CS}$		-	-	0.10		
Drain-source on-state resistance	R <sub>DS(on)</sub>	40	$I_{\rm D} = 10 {\rm A}^2$ $I_{\rm D} = 8.5 {\rm A}^{\rm b}$	-	-	0.10	Ω	
Forward transconductance	<b>G</b> .		$I_D = 8.5 \text{ A}^{\circ}$ 5 V, $I_D = 10 \text{ A}^{b}$	7.3	-	- 0.14		
	9 <sub>fs</sub>	v <sub>DS</sub> = 2	$5 \text{ V}, \text{I}_{\text{D}} = 10 \text{ A}^{-1}$	7.5	<u> </u>		S	
Dynamic Input capacitance	<u> </u>				870	<b>_</b>	1	
	C <sub>iss</sub>		V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1.0 MHz, see fig. 5		-	-	pF	
Output capacitance	C <sub>oss</sub>				360			
Reverse transfer capacitance	C <sub>rss</sub>		I <sub>D</sub> = 17 A, V <sub>DS</sub> = 48 V,	-	53	-	nC	
Total gate charge	Qg			-	-	18		
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 5.0 V	see fig. 6 and 13 <sup>b</sup>	-		4.5		
Gate-drain charge	Q <sub>gd</sub>			-	-	12		
Turn-on delay time	t <sub>d(on)</sub>	_	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 17 \text{ A},$ $\text{R}_{g} = 9.0 \ \Omega, \text{ R}_{D} = 1.7 \ \Omega, \text{ see fig. } 10^{\text{b}}$		11	-	- ns	
Rise time	t <sub>r</sub>				110	-		
Turn-off delay time	t <sub>d(off)</sub>	$n_g = 9.0 $ s2, $n_c$			23	-		
Fall time	t <sub>f</sub>				41	-		
Internal drain inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	nH	
Internal source inductance	LS	package and cer die contact	-	7.5	-			
Drain-Source Body Diode Characteristic	cs							
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	17	A	
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	-	68		
Body diode voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>5</sub>	$T_{J} = 25 \text{ °C}, I_{S} = 17 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	1.5	V	
Body diode reverse recovery time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = 17 A, dl/dt = 100 A/μs <sup>b</sup>		-	110	260	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>			-	0.49	1.5	μC	
Forward turn-on time	t <sub>on</sub>	Intrinsic turn	on time is negligible (tu	n-on is do	minated h	vls and	<u> </u>	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

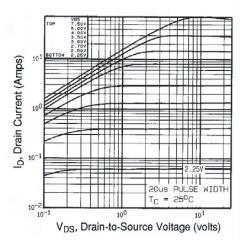


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

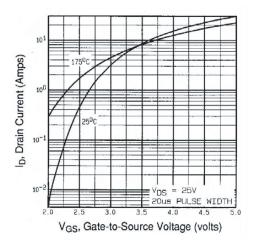


Fig. 3 - Typical Transfer Characteristics

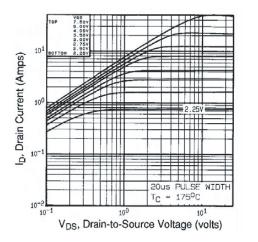


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C

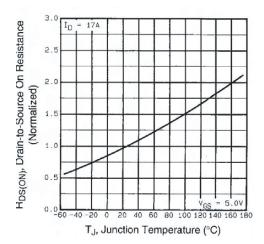


Fig. 4 - Normalized On-Resistance vs. Temperature

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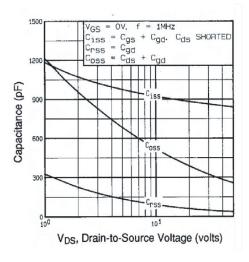
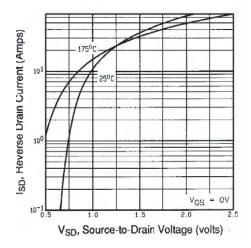


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





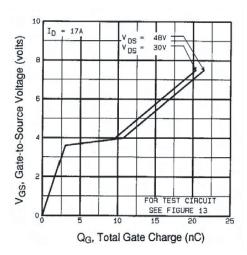


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

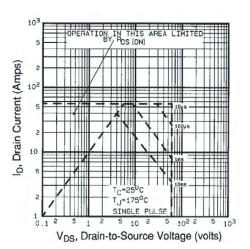


Fig. 8 - Maximum Safe Operating Area



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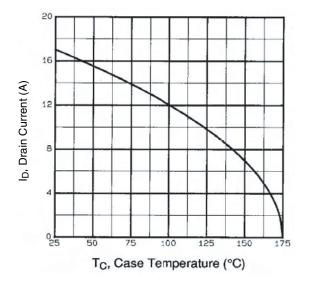


Fig. 9 - Maximum Drain Current vs. Case Temperature

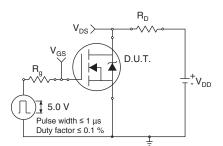


Fig. 10a - Switching Time Test Circuit

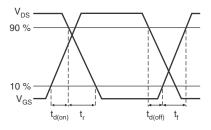


Fig. 10b - Switching Time Waveforms

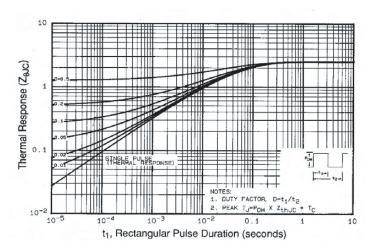


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

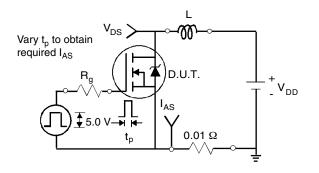


Fig. 12a - Unclamped Inductive Test Circuit

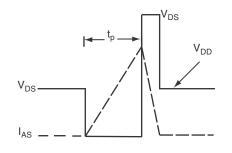


Fig. 12b - Unclamped Inductive Waveforms

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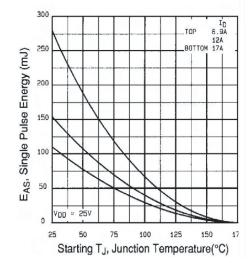


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

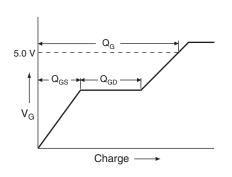


Fig. 13a - Basic Gate Charge Waveform

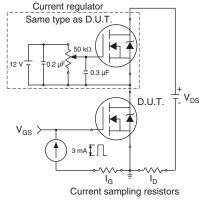


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit

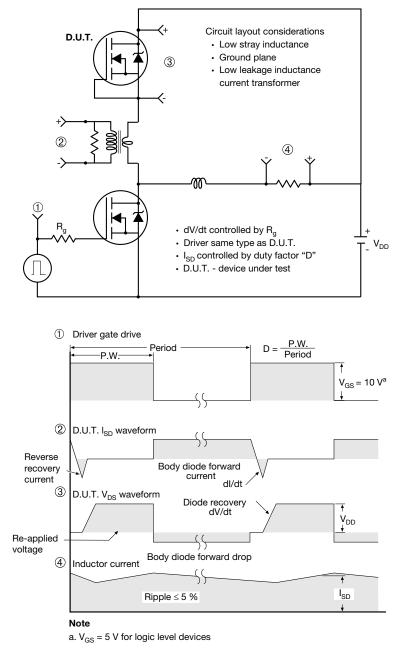


Fig. 14 - For N-Channel

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